

Symbol	Parameter	Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage	30	V
V <sub>GS</sub>	Gate to Source Voltage	±20	V
	Drain Current Continuous ( $V_{GS}$ = 10V, $T_C$ < 163°C)	80	А
I <sub>D</sub>	Continuous ( $V_{GS} = 5V$ , $T_C < 162^{\circ}C$ )	80	Α
	Continuous (V <sub>GS</sub> = 10V, T <sub>C</sub> = 25°C, with $R_{\theta JA}$ = 43°C/W)	31	Α
	Pulsed	Figure 4	Α
E <sub>AS</sub>	SinglePulseAvalancheEnergy (Note1)	947	mJ
n	Power Dissipation	254	W
P <sub>D</sub>	Derate above 25°C	1.7	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature	-55 to +175	°C

## **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance Junction to Case	0.59	°C/W
$R_{\thetaJA}$	Thermal Resistance Junction to Ambient (Note 2)	62	°C/W
$R_{ hetaJA}$	Thermal Resistance Junction to Ambient TO-263,1in <sup>2</sup> copper pad area	43	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8860	FDB8860	TO-263AB	330mm	24mm	800units

## Electrical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 1mA, V_{GS} = 0V$	30	-	-	V
I	Zero Gate Voltage Drain Current	$V_{DS} = 24V$	-	-	1	μA
DSS	Zelo Gale Voltage Dialit Guitent	$V_{GS} = 0V$ $T_J = 150^{\circ}C$	-	-	250	μΛ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V$	-	-	±100	nA

## On Characteristics

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	1.7	3	V
		$I_{D} = 80A, V_{GS} = 10V$	-	1.6	2.3	
		$I_{D} = 80A, V_{GS} = 5V$	-	1.9	2.6	
R <sub>DS(ON)</sub>	Drain to Source On Resistance	$I_{D} = 80A, V_{GS} = 4.5V$	-	2.1	2.7	mΩ
		I <sub>D</sub> = 80A, V <sub>GS</sub> = 10V, T <sub>J</sub> = 175°C	-	2.5	3.6	

## **Dynamic Characteristics**

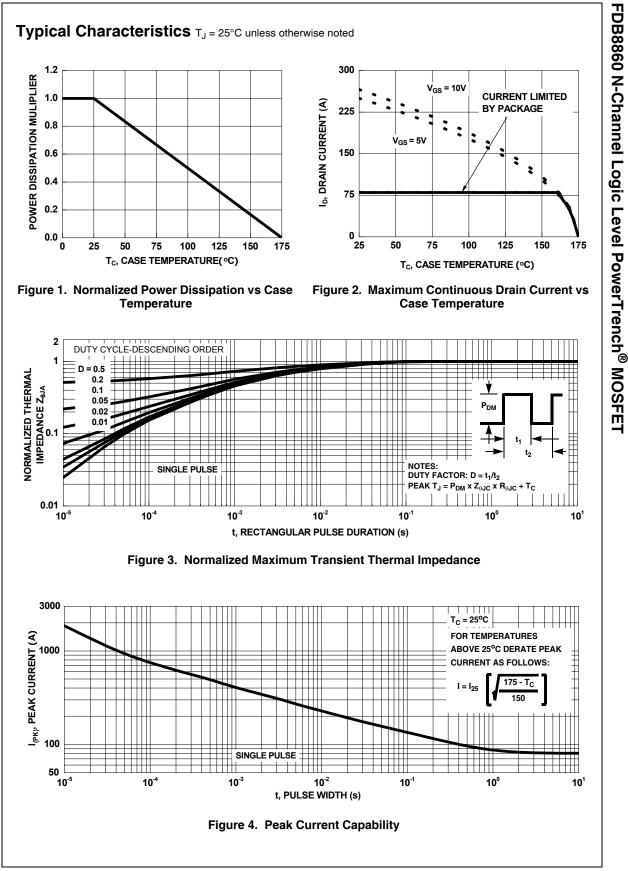
CISS	Input Capacitance		0.4	-	9460	12585	pF
C <sub>OSS</sub>	Output Capacitance	— V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, — f = 1MHz		-	1710	2275	рF
C <sub>RSS</sub>	Reverse Transfer Capacitance			-	1050	1575	pF
R <sub>G</sub>	Gate Resistance	f = 1MHz		-	1.8	-	Ω
Q <sub>g(TOT)</sub>	Total Gate Charge at 10V	V <sub>GS</sub> = 0V to 10V		-	165	214	nC
Q <sub>g(5)</sub>	Total Gate Charge at 5V	$V_{GS} = 0V$ to 5V	1	-	89	115	nC
Q <sub>g(TH)</sub>	Threshold Gate Charge	$V_{GS} = 0V$ to 1V	$V_{DD} = 15V$	-	9.1	12	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		I <sub>D</sub> = 80A I <sub>a</sub> = 1.0mA	-	26	-	nC
Q <sub>gs2</sub>	Gate Charge Threshold to Plateau		-g = 1.011/1	-	18	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	-	33	-	nC

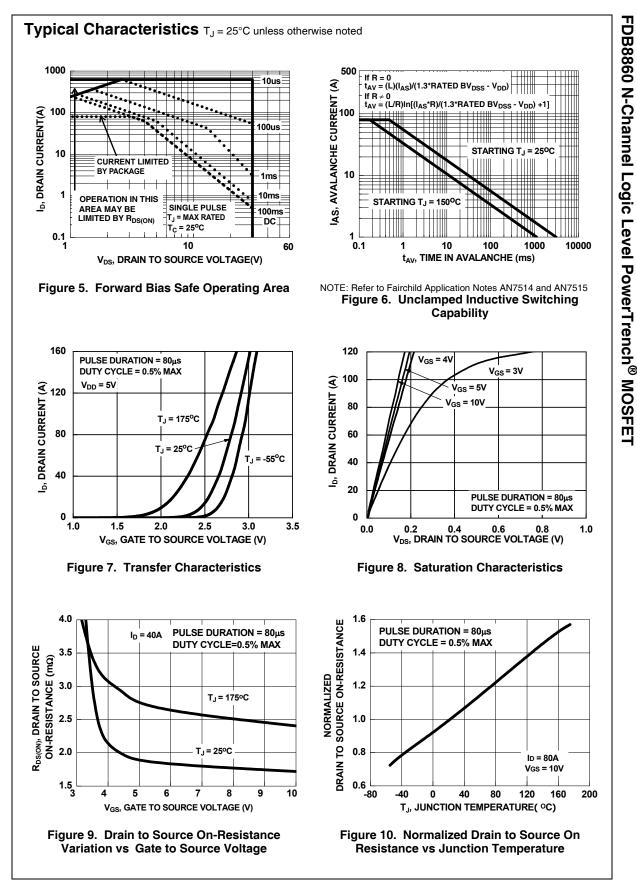
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Switching	g Characteristics					
t <sub>(on)</sub>	Turn-On Time		-	-	340	ns
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 15V, I <sub>D</sub> = 80A	-	14	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	213	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 5V, R_{GS} = 1\Omega$	-	79	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	49	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	192	ns

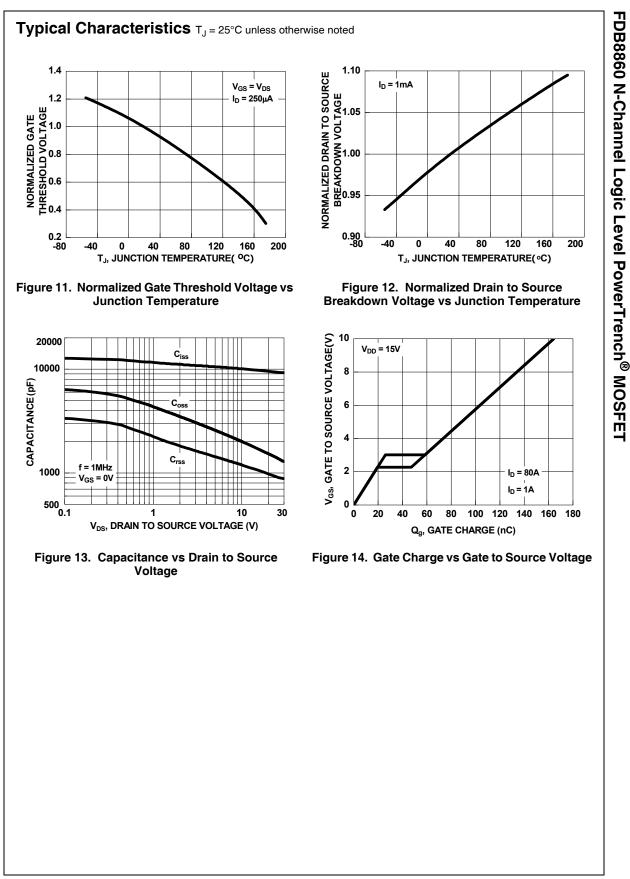
V	Source to Drain Diode Voltage	$I_{SD} = 80A$	-	-	1.25	v
$V_{SD}$	Source to Drain Diode Voltage	I <sub>SD</sub> = 40A	-	-	1.0	V
t <sub>rr</sub>	Reverse Recovery Time	$I_{SD} = 80A$ , $dI_{SD}/dt = 100A/\mu s$	-	-	43	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{SD} = 80A$ , $dI_{SD}/dt = 100A/\mu s$	-	-	29	nC

Notes: 1: Starting  $T_J = 25^{\circ}$ C, L =0.47mH, I<sub>AS</sub> = 64A , V<sub>DD</sub> = 30V, V<sub>GS</sub> = 10V. 2: Pulse width = 100s

©2010 Fairchild Semiconductor Corporation FDB8860 Rev.A2









SEMICONDUCTOR

#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks

AccuPower™	F-PFS™	PowerTrench <sup>®</sup>	The Power Franchise <sup>®</sup>
Auto-SPM™	FRFET®	PowerXS™	The Right Technology for Your Success™
Build it Now™	Global Power Resource <sup>SM</sup>	Programmable Active Droop™	me ®
CorePLUS™	Green FPS™	QFET®	P wer franchise
CorePOWER™	Green FPS™ e-Series™	QS™	TinyBoost™
CROSSVOLT™	G <i>max</i> ™	Quiet Series <sup>™</sup>	TinyBuck™
CTL™	GTO™	RapidConfigure™	TinyCalc™
Current Transfer Logic™	IntelliMAX™		TinyLogic®
DEUXPEED®	ISOPLANAR™		TINYOPTO™
Dual Cool™	MegaBuck™	Saving our world, 1mW/W/kW at a time™	TinyPower™
EcoSPARK <sup>®</sup>	MICROCOUPLER™	SignalWise™	TinyPWM™
EfficentMax™	MicroFET™	SmartMax™	TinyWire™
ESBC™	MicroPak™	SMART START™	TriFault Detect™
R	MicroPak2 <sup>™</sup>	SPM®	TRUECURRENT™*
T	MillerDrive™	STEALTH™	μSerDes™
Fairchild®	MotionMax™	SuperFET <sup>®</sup>	µJer Des
Fairchild Semiconductor®	Motion-SPM <sup>™</sup>	SuperSOT™-3	$\mathcal{M}$
FACT Quiet Series™	OptiHiT™	SuperSOT™-6	/ SerDes" UHC <sup>®</sup>
FACT®	OPTOLOGIC®	SuperSOT <sup>™</sup> -8	
FAST®	OPTOPLANAR®	SupreMOS <sup>®</sup>	Ultra FRFET™
FastvCore™	21s <sup>®</sup>	SyncFET™	UniFET™
FETBench™	U.	Sync-Lock™	VCX™
FlashWriter <sup>®</sup> *	PDP SPM™	SYSTEM ®*	VisualMax™
FPS™	Power-SPM™	GENERAL	XS™
	Corporation, used under license by		

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or 2. system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	•	Re

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: